

# **Customer Information Notification**

Issue Date: 03-Nov-2017 Effective Date: 04-Nov-2017

Here's your personalized quality information concerning products Digi-Key purchased from NXP. For detailed information we invite you to view this notification online

# 2017100221



Change Category				
[] Wafer Fab Process	[] Assembly Process	[] Product Marking	[] Test Location	[] Design
[] Wafer Fab Materials	[] Assembly Materials	[] Mechanical Specification	[]Test Process	[] Errata
[X] Wafer Fab Location	[] Assembly Location	[] Packing/Shipping/Labeling	[] Test gEquipment	[] Electrical spec./Test coverage

Notification of Unaffected Products From Distributed FPCN\_201704020F01

#### **Information Notification**

NXP Semiconductors previously distributed FPCN\_201704020F01 titled "AEC Grade 1 MC9S12G64/48 (48/64LQFP) and MC9S12G32/16 (48LQFP/48QFN) FAB EXPANSION (NXP-ATMC TO TSMC3)" on 16-August-2017 which contained product part numbers covered by a seperate FPCN.

General Market Product Part Numbers not covered by FPCN 201704020F01:

- S9S12G48F1CLC/R
- S9S12G48F1VLC/R
- S9S12GN16F1MLC/R
- S9S12G64F1CLC
- S9S12GN32F1MLC/R
- S9S12GN48F1VLC/R
- S9S12G48F1MLC/R
- S9S12G64F1VLC
- S9S12GN16F1CLC/R
- S9S12G64F1MLC
- S9S12GN32F1CLC

## S9S12GN48F1CLC

FPCN\_201704020F02 was distributed September 2017 to address the above general market product part numbers.

FPCN\_201704020F03 was also distributed to address custom mask set part numbers for ATMC\_N75C. Why do we issue this Information Notification

To notify of unaffected product part numbers previously distributed under FPCN 201704020F01.

#### **Related Notifications**

#### Notification Issue Date Effective DateTitle

201704020F0116-Aug- 13-Nov-2017 PCN: AEC Grade 1 MC9S12G64/48 (48/64LQFP) and

2017 MC9S12G32/16 (48LQFP/48QFN) FAB EXPANSION (NXP-

ATMC TO TSMC3)

#### **Contact and Support**

For all inquiries regarding the ePCN tool application or access issues, please contact NXP "Global Quality Support Team".

For all Quality Notification content inquiries, please contact your local NXP Sales Support team.

For specific questions on this notice or the products affected please contact our specialist directly:

Name Mervl Bender

Position NXP AMP Commercial Marketing

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At NXP Semiconductors we are constantly striving to improve our product and processes to ensure they reach the highest possible Quality Standards.

Customer Focus, Passion to Win.

NXP Quality Management Team.

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Changed Orderable Part#	Changed Part 12NC	Changed Part Number	Changed Part Description	Package Name	Status	Product Line
S9S12G48F1MLC	935317781557	S9S12G48F1MLC	16 BIT 48K FLASH 4KB RAM	LQFP32	RFS	BL Auto Micro Processors
S9S12G48F1CLC	935310989557	S9S12G48F1CLC	S12 Core,48k Flash	LQFP32	RFS	BL Auto Micro Processors
S9S12GN16F1MLC	935311279557	S9S12GN16F1MLC	16-bit,16k Flash,2k RAM	LQFP32	RFS	<b>BL Auto Micro Processors</b>